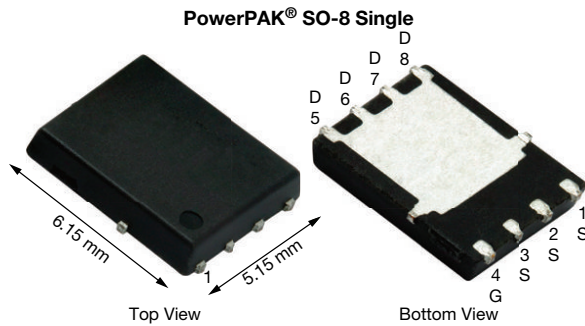


## N-Channel 60 V (D-S) MOSFET



PRODUCT SUMMARY	
$V_{DS}$ (V)	60
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10$ V	0.0017
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5$ V	0.0020
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 6$ V	0.0026
$Q_g$ typ. (nC)	52
$I_D$ (A)	100 <sup>a, g</sup>
Configuration	Single

### FEATURES

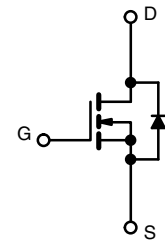
- TrenchFET® Gen IV power MOSFET
- Very low  $R_{DS} - Q_g$  figure-of-merit (FOM)
- Tuned for the lowest  $R_{DS} - Q_{oss}$  FOM
- 100 %  $R_g$  and UIS tested
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- Synchronous rectification
- Primary side switch
- DC/DC converter
- Solar micro inverter
- Motor drive switch
- Battery and load switch
- Industrial



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8 Single
Lead (Pb)-free and halogen-free	SiR626DP-T1-RE3

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	$V_{DS}$	60	V
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current ( $T_J = 150$ °C)	$I_D$	$T_C = 25$ °C	100 <sup>a</sup>
		$T_C = 70$ °C	100 <sup>a</sup>
		$T_A = 25$ °C	42.8 <sup>b, c</sup>
		$T_A = 70$ °C	34.2 <sup>b, c</sup>
Pulsed drain current ( $t = 100$ $\mu$ s)	$I_{DM}$	200	A
Continuous source-drain diode current	$I_S$	$T_C = 25$ °C	100 <sup>a</sup>
		$T_A = 25$ °C	5.6 <sup>b, c</sup>
Single pulse avalanche current	$I_{AS}$	50	mJ
Single pulse avalanche energy	$E_{AS}$	125	
Maximum power dissipation	$P_D$	$T_C = 25$ °C	104
		$T_C = 70$ °C	66.6
		$T_A = 25$ °C	6.25 <sup>b, c</sup>
		$T_A = 70$ °C	4 <sup>b, c</sup>
Operating junction and storage temperature range	$T_J, T_{stg}$	-55 to +150	°C
Soldering recommendations (peak temperature) <sup>c</sup>		260	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	$t \leq 10$ s	$R_{thJA}$	15	20	°C/W
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	0.9	1.2	

#### Notes

- Package limited.
- Surface mounted on 1" x 1" FR4 board.
- $t = 10$  s.
- See solder profile ([www.vishay.com/doc?73257](http://www.vishay.com/doc?73257)). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 54 °C/W.
- $T_C = 25$  °C.

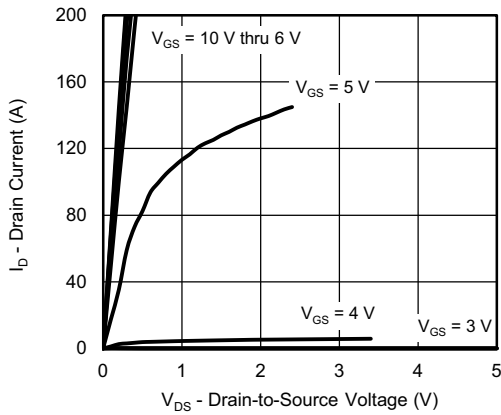
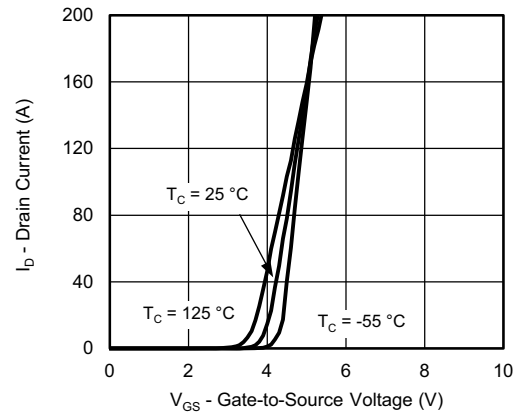
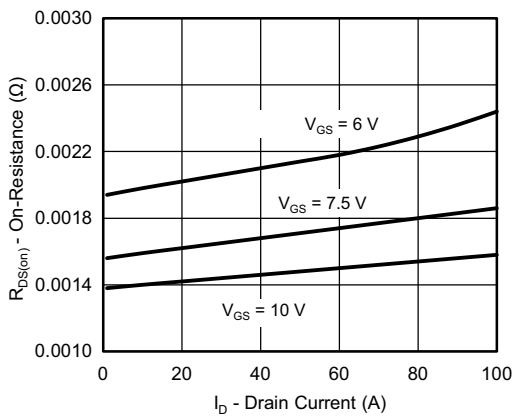
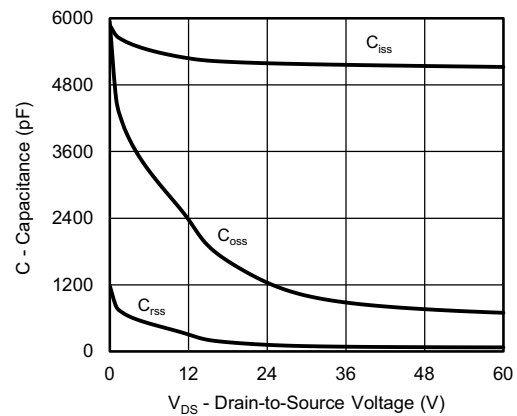
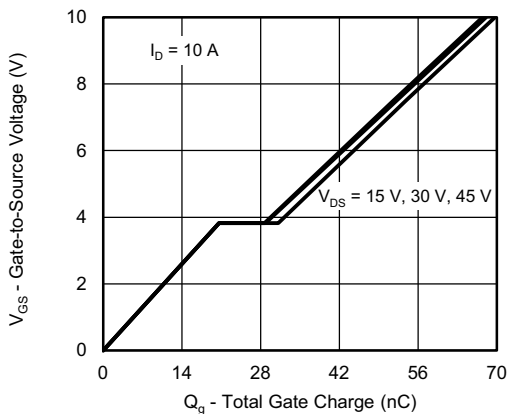
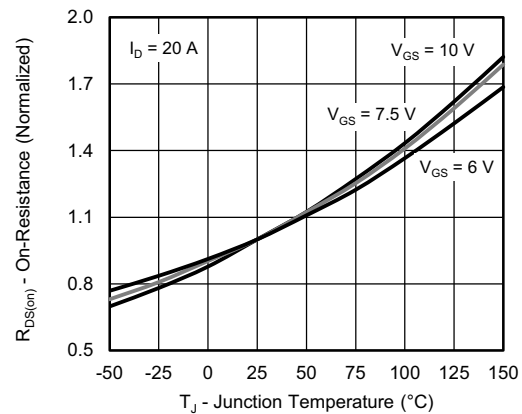


SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> temperature coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	I <sub>D</sub> = 10 mA	-	35	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA	-	-7.4	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	3.4	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V	-	-	100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V	-	-	1	μA
		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ 10 V, V <sub>GS</sub> = 10 V	40	-	-	A
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	0.0014	0.0017	Ω
		V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 20 A	-	0.0016	0.0020	
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 10 A	-	0.0020	0.0026	
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A	-	78	-	S
<b>Dynamic <sup>b</sup></b>						
Input capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	5130	-	pF
Output capacitance	C <sub>OSS</sub>		-	992	-	
Reverse transfer capacitance	C <sub>RSS</sub>		-	94	-	
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	68	102	nC
		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 10 A	-	52	78	
Gate-source charge	Q <sub>gs</sub>		-	21	-	
Gate-drain charge	Q <sub>gd</sub>		-	8.2	-	
Output charge	Q <sub>OSS</sub>		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	-	68	
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.3	0.91	1.6	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 30 V, R <sub>L</sub> = 3 Ω, I <sub>D</sub> ≅ 10 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 1 Ω	-	16	32	ns
Rise time	t <sub>r</sub>		-	24	48	
Turn-off delay time	t <sub>d(off)</sub>		-	30	60	
Fall time	t <sub>f</sub>		-	11	22	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 30 V, R <sub>L</sub> = 3 Ω, I <sub>D</sub> ≅ 10 A, V <sub>GEN</sub> = 7.5 V, R <sub>g</sub> = 1 Ω	-	19	38	
Rise time	t <sub>r</sub>		-	25	50	
Turn-off delay time	t <sub>d(off)</sub>		-	27	54	
Fall time	t <sub>f</sub>		-	12	24	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	100	A
Pulse diode forward current	I <sub>SM</sub>		-	-	200	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.72	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-	54	108	ns
Body diode reverse recovery charge	Q <sub>rr</sub>		-	64	128	nC
Reverse recovery fall time	t <sub>a</sub>		-	35	-	ns
Reverse recovery rise time	t <sub>b</sub>		-	29	-	

**Notes**

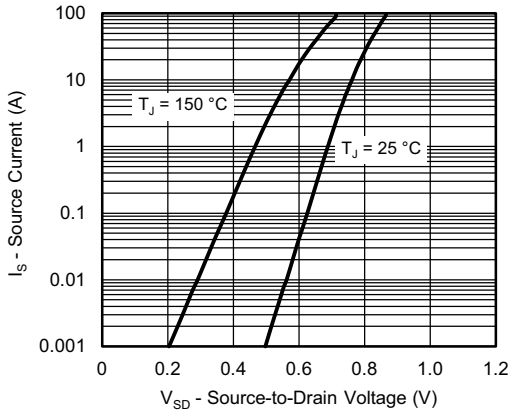
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

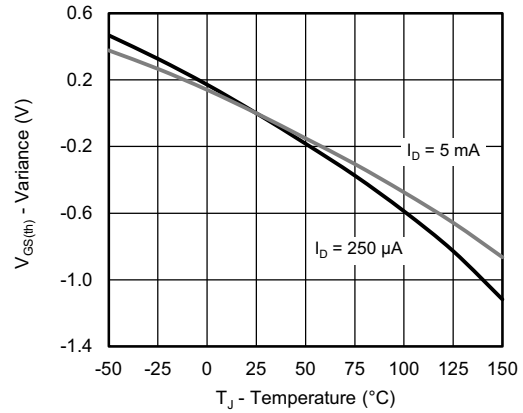
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current and Gate Voltage**

**Capacitance**

**Gate Charge**

**On-Resistance vs. Junction Temperature**



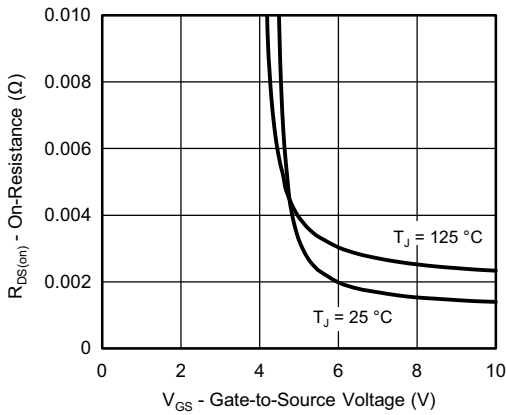
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



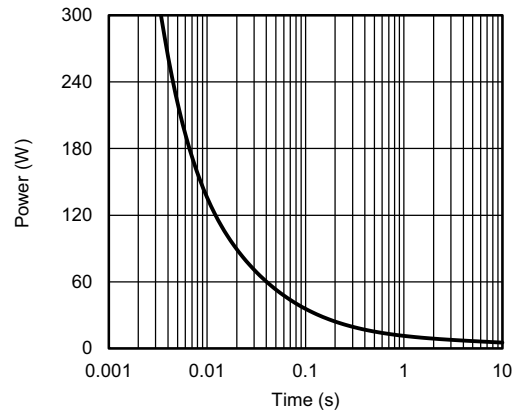
Source-Drain Diode Forward Voltage



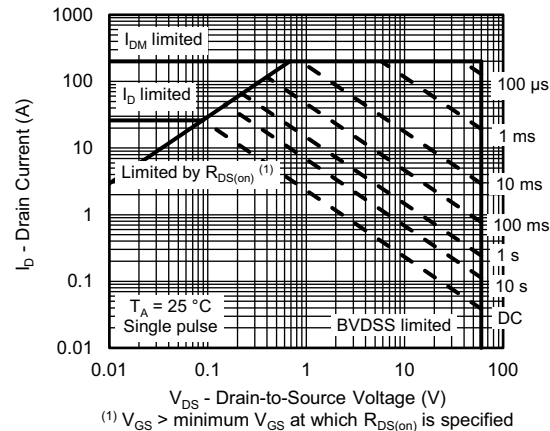
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



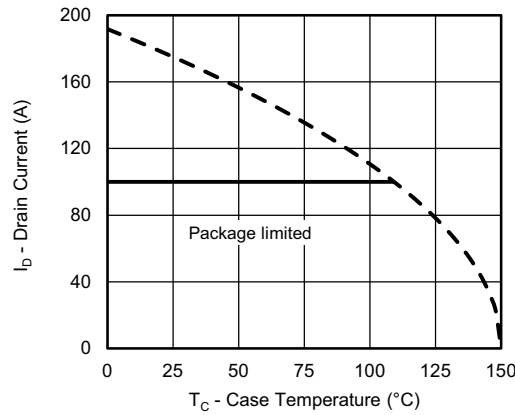
Single Pulse Power, Junction-to-Ambient



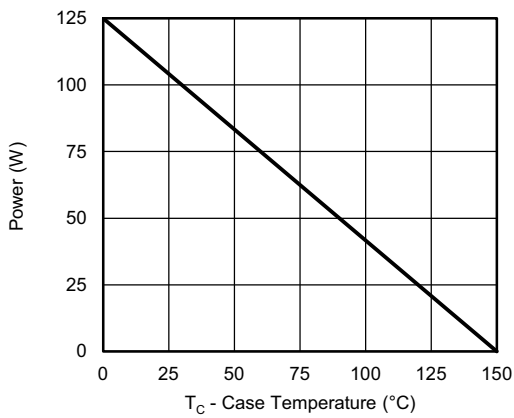
Safe Operating Area, Junction-to-Ambient



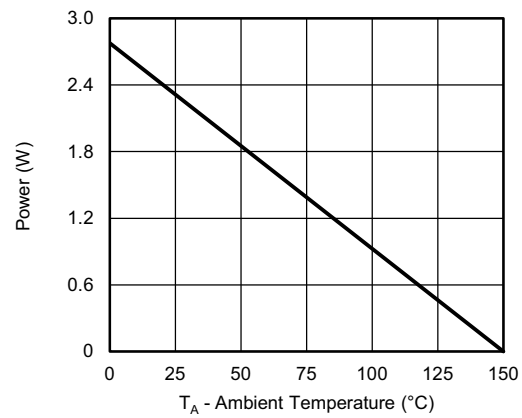
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



**Current Derating <sup>a</sup>**



**Power, Junction-to-Case**



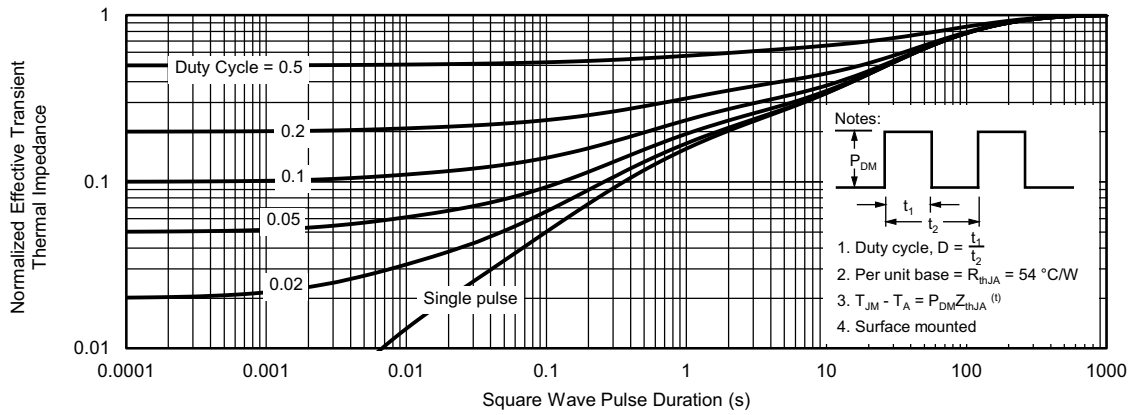
**Power, Junction-to-Ambient**

**Note**

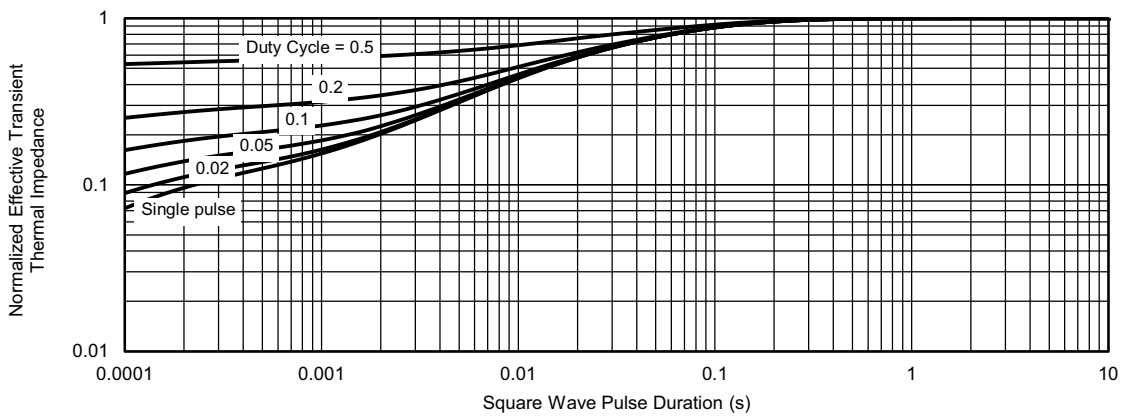
- a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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